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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Last Time Buy
Core Processor	ARM920T
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	166MHz
Co-Processors/DSP	-
RAM Controllers	SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	1/10/100Mbps (1)
SATA	-
USB	USB 2.0 (2)
Voltage - I/O	1.8V, 3.3V
Operating Temperature	0°C ~ 70°C (TA)
Security Features	Hardware ID
Package / Case	208-LQFP
Supplier Device Package	208-LQFP
Purchase URL	https://www.e-xfl.com/product-detail/cirrus-logic/ep9301-cqz

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Processor Core - ARM920T

The ARM920T is a Harvard architecture processor with separate 16-kbyte instruction and data caches with an 8-word line length but a unified memory. The processor utilizes a five-stage pipeline consisting of fetch, decode, execute, memory, and write stages. Key features include:

- ARM (32-bit) and Thumb (16-bit compressed) instruction sets
- 32-bit Advanced Micro-Controller Bus Architecture (AMBA)
- 16 kbyte Instruction Cache with lockdown
- 16 kbyte Data Cache (programmable write-through or write-back) with lockdown
- MMU for Linux®, Microsoft® Windows® CE and other operating systems
- Translation Look Aside Buffers with 64 Data and 64 Instruction Entries
- Programmable Page Sizes of 1 Mbyte, 64 kbyte, 4 kbyte, and 1 kbyte
- Independent lockdown of TLB Entries

MaverickKey™ Unique ID

MaverickKey unique hardware programmed IDs are a solution to the growing concern over secure web content and commerce. With Internet security playing an important role in the delivery of digital media such as books or music, traditional software methods are quickly becoming unreliable. The MaverickKey unique IDs provide OEMs with a method of utilizing specific hardware IDs such as those assigned for SDMI (Secure Digital Music Initiative) or any other authentication mechanism.

Both a specific 32-bit ID as well as a 128-bit random ID is programmed into the EP9301 through the use of laser probing technology. These IDs can then be used to match secure copyrighted content with the ID of the target device the EP9301 is powering, and then deliver the copyrighted information over a secure connection. In addition, secure transactions can benefit by also matching device IDs to server IDs. MaverickKey IDs provide a level of hardware security required for today's Internet appliances.

General Purpose Memory Interface (SDRAM, SRAM, ROM, FLASH)

The EP9301 features a unified memory address model where all memory devices are accessed over a common address/data bus. Memory accesses are performed via the Processor bus. The SRAM memory controller supports 8- and 16-bit devices and accommodates an internal boot ROM concurrently with 16-bit SDRAM memory.

- 1 to 4 banks of 16-bit, 66 MHz SDRAM
- Address and data bus shared between SDRAM, SRAM, ROM, and FLASH memory
- NOR FLASH memory supported

Table B. General Purpose Memory Interface Pin Assignments

Pin Mnemonic	Pin Description
SDCLK	SDRAM Clock
SDCLKEN	SDRAM Clock Enable
SDCSn[3:0]	SDRAM Chip Selects 3-0
RASn	SDRAM RAS
CASn	SDRAM CAS
SDWEn	SDRAM Write Enable
CSn[7:6] and CSn[3:0]	Chip Selects 7, 6, 3, 2, 1, 0
AD[25:0]	Address Bus 25-0
DA[15:0]	Data Bus 15-0
DQMn[1:0]	SDRAM Output Enables / Data Masks
WRn	SRAM Write Strobe
RDn	SRAM Read / OE Strobe
WAITn	SRAM Wait Input

Ethernet Media Access Controller (MAC)

The MAC subsystem is compliant with the ISO/TEC 802.3 topology for a single shared medium with several stations. Multiple MII-compliant PHYs are supported. Features include:

- Supports 1/10/100 Mbps transfer rates for home / small-business / large-business applications
- Interfaces to an off-chip PHY through industry standard Media Independent Interface (MII)

Table C. Ethernet Media Access Controller Pin Assignments

Pin Mnemonic	Pin Description
MDC	Management Data Clock
MDIO	Management Data I/O
RXCLK	Receive Clock
MIIRXD[3:0]	Receive Data
RXDVAL	Receive Data Valid
RXERR	Receive Data Error
TXCLK	Transmit Clock
MIITXD[3:0]	Transmit Data
TXEN	Transmit Enable
TXERR	Transmit Error
CRS	Carrier Sense
CLD	Collision Detect

Serial Interfaces (SPI, I^{2}S, and AC ’97)

The Serial Peripheral Interface (SPI) port can be configured as a master or a slave, supporting the National Semiconductor®, Motorola®, and Texas Instruments® signaling protocols.

The AC'97 port supports multiple codecs for multichannel audio output with a single stereo input. The I^{2}S port supports stereo 24-bit audio.

These ports are multiplexed so that the I^{2}S port will take over either the AC'97 pins or the SPI pins.

- Normal Mode: One SPI Port and one AC’97 Port
- I^{2}S on SSP Mode: One AC’97 Port and one I^{2}S Port
- I^{2}S on AC’97 Mode: One SPI Port and one I^{2}S Port

Note: I^{2}S may not be output on AC’97 and SSP ports at the same time.

Table D. Audio Interfaces Pin Assignment

Pin Name	Normal Mode	I^{2}S on SSP Mode	I^{2}S on AC'97 Mode
	Pin Description	Pin Description	Pin Description
SCLK1	SPI Bit Clock	I2S Serial Clock	SPI Bit Clock
SFRM1	SPI Frame Clock	I2S Frame Clock	SPI Frame Clock
SSPRX1	SPI Serial Input	I2S Serial Input	SPI Serial Input
SSPTX1	SPI Serial Output	I2S Serial Output	SPI Serial Output
		(No I2S Master Clock)	
ARSTn	AC'97 Reset	AC'97 Reset	I2S Master Clock
ABITCLK	AC'97 Bit Clock	AC'97 Bit Clock	I2S Serial Clock
ASYNC	AC'97 Frame Clock	AC'97 Frame Clock	I2S Frame Clock
ASDI	AC'97 Serial Input	AC'97 Serial Input	I2S Serial Input
ASDO	AC'97 Serial Output	AC'97 Serial Output	I2S Serial Output

12-bit Analog-to-digital Converter (ADC)

The ADC block consists of a 12-bit analog-to-digital converter with a analog input multiplexer. The multiplexer can select to measure battery voltage and other miscellaneous voltages on the external measurement pins. Features include:

- 5 external pins for ADC measurement
- Measurement pin input range: 0 to 3.3 V.
- ADC-conversion-complete interrupt signal

Table E. 12-bit Analog-to-Digital Converter Pin Assignments

Pin Mnemonic	Pin Description
ADC[0] (Ym, pin 135)	External Analog Measurement Input
ADC[1] (sXp, pin 134)	External Analog Measurement Input
ADC[2] (sXm, pin 133)	External Analog Measurement Input
ADC[3] (sYp, pin 132)	External Analog Measurement Input
ADC[4] (sYm, pin 131)	External Analog Measurement Input

Universal Asynchronous Receiver/Transmitters (UARTs)

Two 16550-compatible UARTs are supplied. One provides asynchronous HDLC (High-level Data Link Control) protocol support for full duplex transmit and receive. The HDLC receiver handles framing, address matching, CRC checking, control-octet transparency, and optionally passes the CRC to the host at the end of the packet. The HDLC transmitter handles framing, CRC generation, and control-octet transparency. The host must assemble the frame in memory before transmission. The HDLC receiver and transmitter use the UART FIFOs to buffer the data streams. The second UART provides IrDA® compatibility.

- UART1 supports modem bit rates up to 115.2 kbps, supports HDLC and includes a 16 byte FIFO for receive and a 16 byte FIFO for transmit. Interrupts are generated on Rx, Tx and modem status change.
- UART2 contains an IrDA encoder operating at either the slow (up to 115 kbps), medium (0.576 or 1.152 Mbps), or fast (4 Mbps) IR data rates. It also has a 16 byte FIFO for receive and a 16 byte FIFO for transmit.

Table F. Universal Asynchronous Receiver/Transmitters Pin Assignments

Pin Mnemonic	Pin Name - Description
TXD0	UART1 Transmit
RXD0	UART1 Receive
CTSn	UART1 Clear To Send / Transmit Enable
DSRn / DCDn	UART1 Data Set Ready / Data Carrier Detect
DTRn	UART1 Data Terminal Ready
RTSn	UART1 Ready To Send
EGPIO[0] / RI	UART1 Ring Indicator
TXD1 / SIROUT	UART2 Transmit / IrDA Output
RXD1 / SIRIN	UART2 Receive / IrDA Input

Dual Port USB Host

The USB Open Host Controller Interface (Open HCI) provides full speed serial communications ports at a baud rate of 12 Mbits/sec. Up to 127 USB devices (printer, mouse, camera, keyboard, etc.) and USB hubs can be connected to the USB host in the USB “tiered-start” topology.

This includes the following feature:

- Compliance with the USB 2.0 specification
- Compliance with the Open HCI Rev 1.0 specification
- Supports both low speed (1.5 Mbps) and full speed (12 Mbps) USB device connections
- Root HUB integrated with 2 downstream USB ports
- Transceiver buffers integrated, over-current protection on ports
- Supports power management
- Operates as a master on the bus

The Open HCI host controller initializes the master DMA transfer with the AHB bus:

- Fetches endpoint descriptors and transfer descriptors
- Accesses endpoint data from system memory
- Accesses the HC communication area
- Writes status and retire transfer descriptor

Table G. Dual Port USB Host Pin Assignments

Pin Mnemonic	Pin Name - Description
USBp[2,0]	USB Positive signals
USBm[2,0]	USB Negative Signals

Note: USBm[1] and USBp[1] are not bonded out.

Two-Wire Interface With EEPROM Support

The two-wire interface provides communication and control for synchronous-serial-driven devices.

Table H. Two-Wire Port with EEPROM Support Pin Assignments

Pin Mnemonic	Pin Name - Description	Alternative Usage
EECLK	Two-wire Interface Clock	General Purpose I/O
EEDATA	Two-wire Interface Data	General Purpose I/O

Real-Time Clock with Software Trim

The software trim feature on the real time clock (RTC) provides software controlled digital compensation of the 32.768 KHz input clock. This compensation is accurate to ± 1.24 sec/month.

Note: A real time clock must be connected to RTCXTALI or the EP9301device will not boot.

Table I. Real-Time Clock with Pin Assignments

Pin Mnemonic	Pin Name - Description
RTCXTALI	Real-Time Clock Oscillator Input
RTCXTALO	Real-Time Clock Oscillator Output

Reset and Power Management

The chip may be reset through the PRSTn pin or through the open drain common reset pin, RSTOn.

Clocks are managed on a peripheral-by-peripheral basis and may be turned off to conserve power.

The processor clock is dynamically adjustable from 0 to 166 MHz.

Table N. Reset and Power Management Pin Assignments

Pin Mnemonic	Pin Name - Description
PRSTn	Power On Reset
RSTOn	User Reset In/Out – Open Drain – Preserves Real Time Clock value

Hardware Debug Interface

The JTAG interface allows use of ARM's Multi-ICE or other in-circuit emulators.

Table O. Hardware Debug Interface

Pin Mnemonic	Pin Name - Description
TCK	JTAG Clock
TDI	JTAG Data In
TDO	JTAG Data Out
TMS	JTAG Test Mode Select
TRSTn	JTAG Port Reset

12-channel DMA Controller

The DMA module contains 12 separate DMA channels. Ten of these may be used for peripheral-to-memory or memory-to-peripheral access. Two of these are dedicated to memory-to-memory transfers. Each DMA channel is connected to the 16-bit DMA request bus.

The request bus is a collection of requests, Serial Audio and UARTs. Each DMA channel can be used independently or dedicated to any request signal. For each DMA channel, source and destination addressing can be independently programmed to increment, decrement, or stay at the same value. All DMA addresses are physical, not virtual addresses.

Internal Boot ROM

The Internal 16 kbyte ROM allows booting from FLASH memory, SPI or UART. Consult the EP93xx User's Manual for operational details.

Electrical Specifications

Absolute Maximum Ratings

(All grounds = 0 V, all voltages with respect to 0 V)

Parameter	Symbol	Min	Max	Unit
Power Supplies	RVDD CVDD VDD_PLL VDD_ADC	- - - -	3.96 2.16 2.16 3.96	V V V V
Total Power Dissipation (Note 1)		-	2	W
Input Current per Pin, DC (Except supply pins)		-	±10	mA
Output current per pin, DC		-	±50	mA
Digital Input voltage (Note 2)		-0.3	RVDD+0.3	V
Storage temperature		-40	+125	°C

Note: 1. Includes all power generated by AC and/or DC output loading.
2. The power supply pins are at recommended maximum values.

WARNING: Operation beyond these limits may result in permanent damage to the device. Normal operation is not guaranteed at these extremes.

Recommended Operating Conditions

(All grounds = 0 V, all voltages with respect to 0 V)

Parameter	Symbol	Min	Typ	Max	Unit
Power Supplies	RVDD CVDD VDD_PLL VDD_ADC	3.0 1.71 1.71 3.0	3.3 1.80 1.80 3.3	3.6 1.94 1.94 3.6	V V V V
Operating Ambient Temperature - Commercial	T_A	0	+25	+70	°C
Operating Ambient Temperature - Industrial	T_A	-40	+25	+85	°C
Processor Clock Speed - Commercial	FCLK	-	-	166	MHz
Processor Clock Speed - Industrial	FCLK	-	-	166	MHz
System Clock Speed - Commercial	HCLK	-	-	66	MHz
System Clock Speed - Industrial	HCLK	-	-	66	MHz

DC Characteristics

(T_A = 0 to 70° C; CVDD = VDD_PLL = 1.8; RVDD = 3.3 V;
All grounds = 0 V; all voltages with respect to 0 V unless otherwise noted)

Parameter			Symbol	Min	Max	Unit
High level output voltage	Iout = -4 mA	(Note 3)	V_{oh}	0.85 × RVDD	-	V
Low level output voltage	Iout = 4 mA		V_{ol}	-	0.15 × RVDD	V
High level input voltage		(Note 4)	V_{ih}	0.65 × RVDD	VDD + 0.3	V
Low level input voltage		(Note 4)	V_{il}	–0.3	0.35 × RVDD	V
High level leakage current	Vin = 3.3 V	(Note 4)	I_{ih}	-	10	µA
Low level leakage current	Vin = 0	(Note 4)	I_{il}	-	-10	µA

Parameter		Min	Typ	Max	Unit
Power Supply Pins (Outputs Unloaded), 25° C					
Power Supply Current:	CVDD / VDD_PLL Total RVDD	- -	180 45	230 80	mA mA
Low-Power Mode Supply Current	CVDD / VDD_PLL Total RVDD	- -	2 1.0	3.5 2	mA mA

Note: 3. For open drain pins, high level output voltage is dependent on the external load.
4. All inputs that do not include internal pull-ups or pull-downs, must be externally driven for proper operation (See Table Q on page 38). If an input is not driven, it should be tied to power or ground, depending on the particular function. If an I/O pin is not driven and programmed as an input, it should be tied to power or ground through its own resistor.

SDRAM Burst Read Cycle

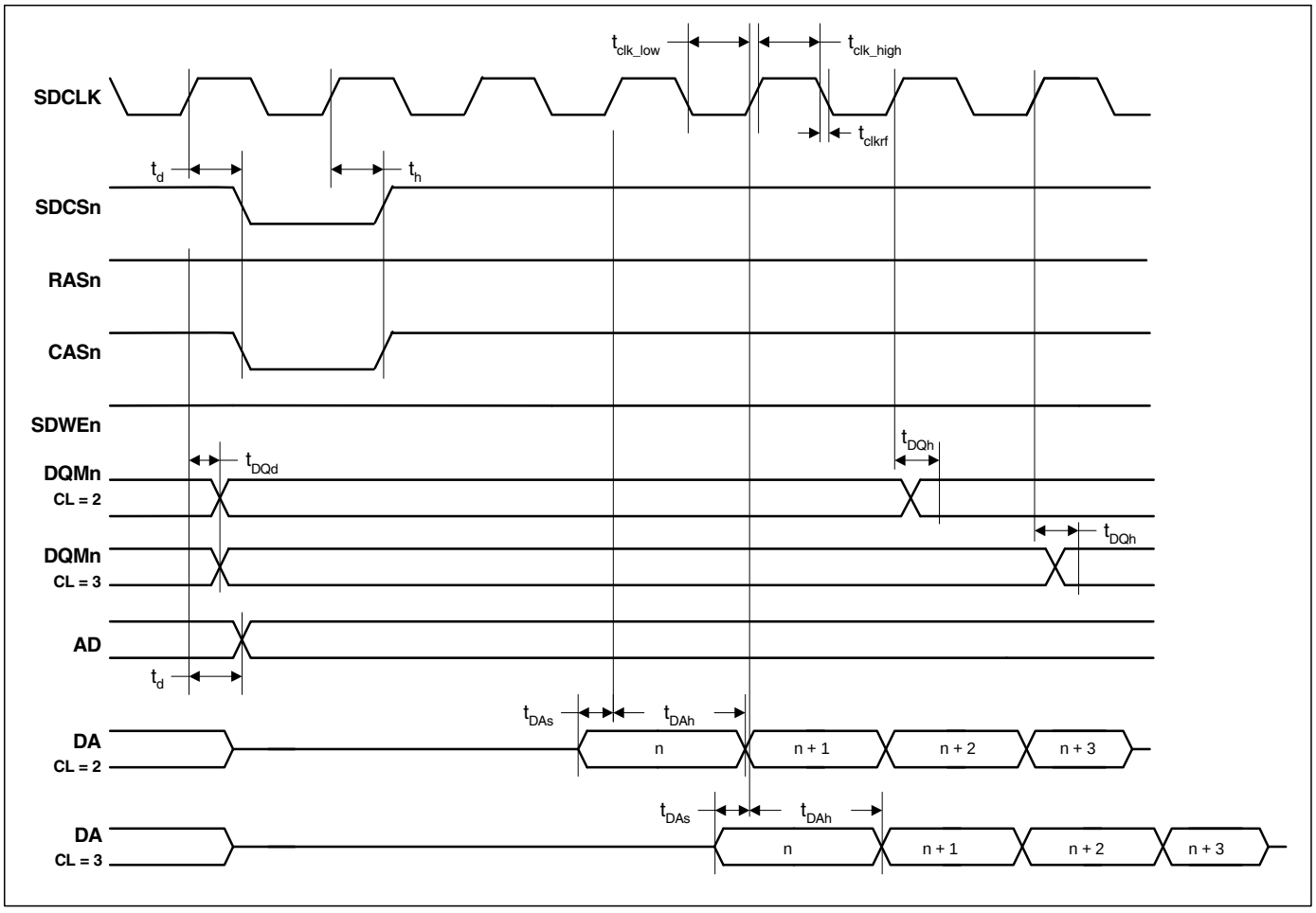


Figure 3. SDRAM Burst Read Cycle Timing Measurement

SDRAM Burst Write Cycle

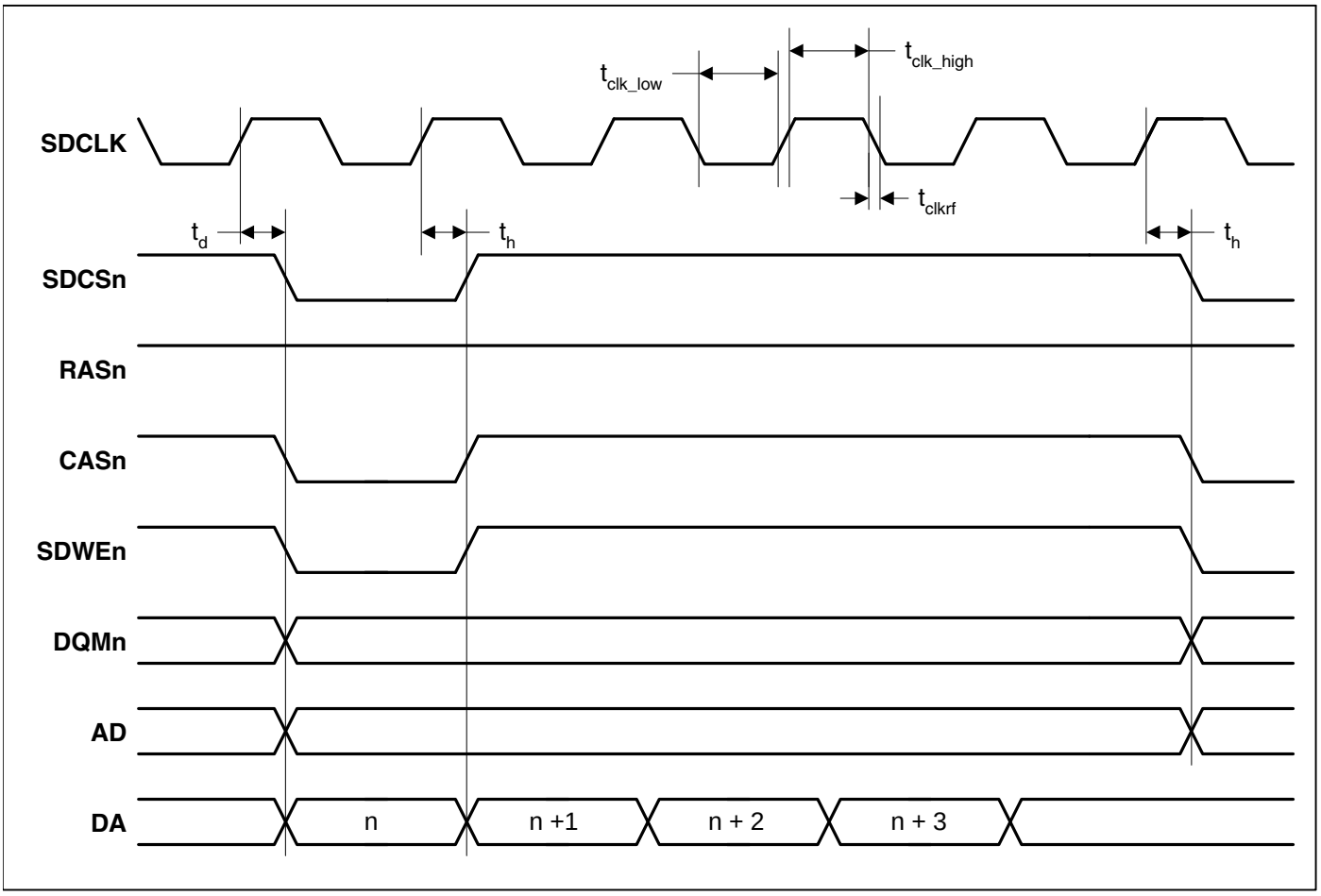


Figure 4. SDRAM Burst Write Cycle Timing Measurement

Static Memory 32-bit Write on 8-bit External Bus

Parameter	Symbol	Min	Typ	Max	Unit
AD setup to WRn assert time	t_{ADs}	$t_{HCLK} - 3$	-	-	ns
WRn/DQMn deassert to AD transition time	t_{ADd}	-	-	$t_{HCLK} + 6$	ns
AD hold from WRn deassert time	t_{ADh}	$t_{HCLK} \times 2$	-	-	ns
CSn hold from WRn deassert time	t_{CSh}	7	-	-	ns
CSn to WRn assert delay time	t_{WRd}	-	-	2	ns
WRn assert time	t_{WRpwL}	-	$t_{HCLK} \times (WST1 + 1)$	-	ns
WRn deassert time	t_{WRpwH}	-	$t_{HCLK} \times 2$	$(t_{HCLK} \times 2) + 14$	ns
CSn to DQMn assert delay time	t_{DQMd}	-	-	1	ns
DQMn assert time	t_{DQMpwL}	-	$t_{HCLK} \times (WST1 + 1)$	-	ns
DQMn deassert time	t_{DQMpwH}	-	-	$(t_{HCLK} \times 2) + 7$	ns
WRn / DQMn deassert to DA transition time	t_{DAh}	t_{HCLK}	-	-	ns
WRn / DQMn assert to DA valid time	t_{DAV}	-	-	8	ns

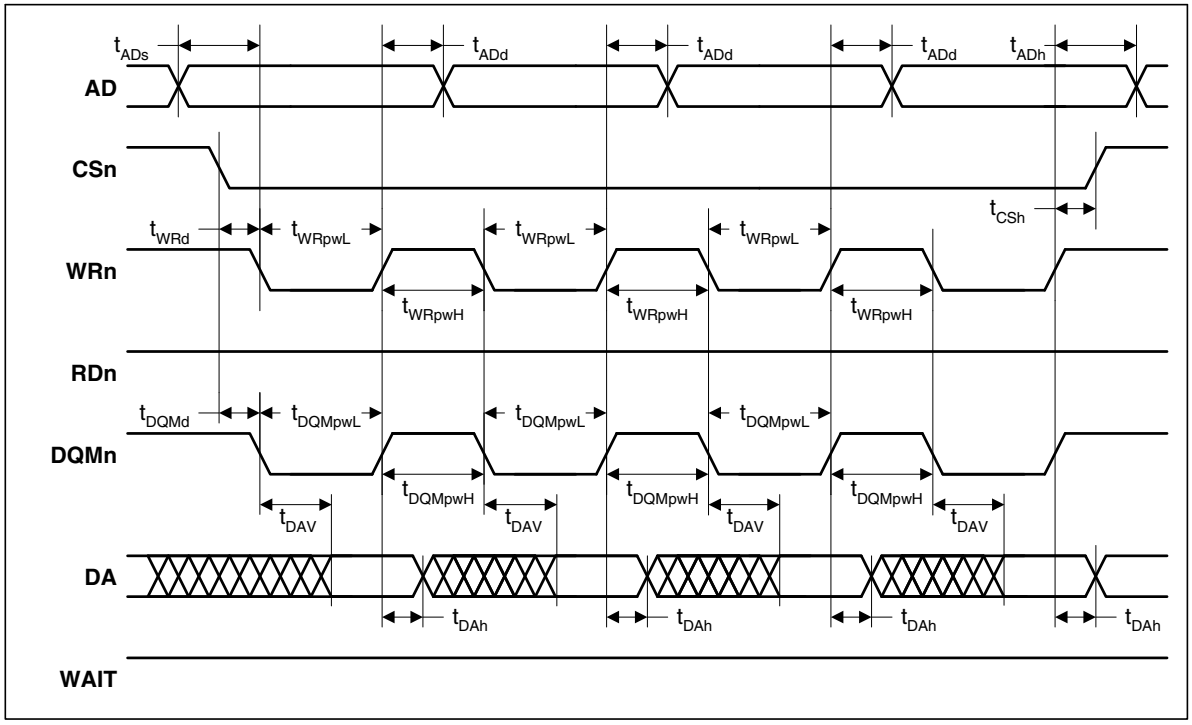


Figure 7. Static Memory Multiple Word Write 8-bit Cycle Timing Measurement

Static Memory Burst Read Cycle

Parameter	Symbol	Min	Typ	Max	Unit
CSn assert to Address 1 transition time	t_{ADd1}	-	$t_{HCLK} \times (WST1 + 1)$	-	ns
Address assert time	t_{ADd2}	-	$t_{HCLK} \times (WST2 + 1)$	-	ns
AD transition to CSn deassert time	t_{ADd3}	-	$t_{HCLK} \times (WST1 + 2)$	-	ns
AD hold from CSn deassert time	t_{ADh}	t_{HCLK}	-	-	ns
CSn to RDn delay time	t_{RDd}	-	-	3	ns
CSn to DQMn assert delay time	t_{DQMd}	-	-	1	ns
DA setup to AD transition time	t_{DAs1}	15	-	-	ns
DA setup to CSn deassert time	t_{DAs2}	t_{HCLK} + 12	-	-	ns
DA hold from AD transition time	t_{DAh1}	0	-	-	ns
DA hold from RDn deassert time	t_{DAh2}	0	-	-	ns

Note: These characteristics are valid when the Page Mode Enable (Burst Mode) bit is set. See the User's Guide for details.

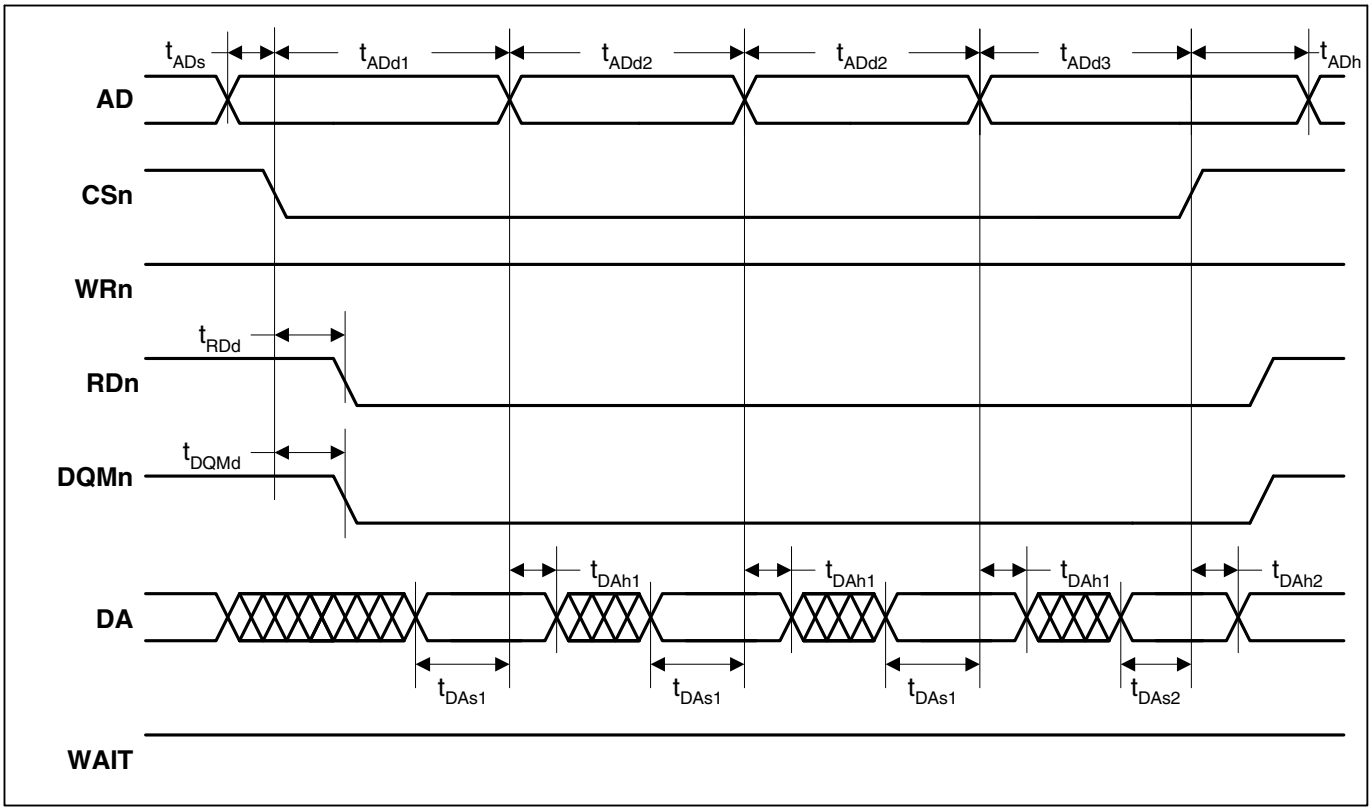


Figure 10. Static Memory Burst Read Cycle Timing Measurement

Static Memory Single Write Wait Cycle

Parameter	Symbol	Min	Typ	Max	Unit
WAIT to WRn deassert delay time	t_{WRd}	$t_{HCLK} \times 2$	-	$t_{HCLK} \times 4$	ns
CSn assert to WAIT time	t_{WAITd}	-	-	$t_{HCLK} \times$ (WST1-2)	ns
WAIT assert time	t_{WAITpw}	$t_{HCLK} \times 2$	-	$t_{HCLK} \times 510$	ns
WAIT to CSn deassert delay time	t_{CSnd}	$t_{HCLK} \times 3$	-	$t_{HCLK} \times 5$	ns

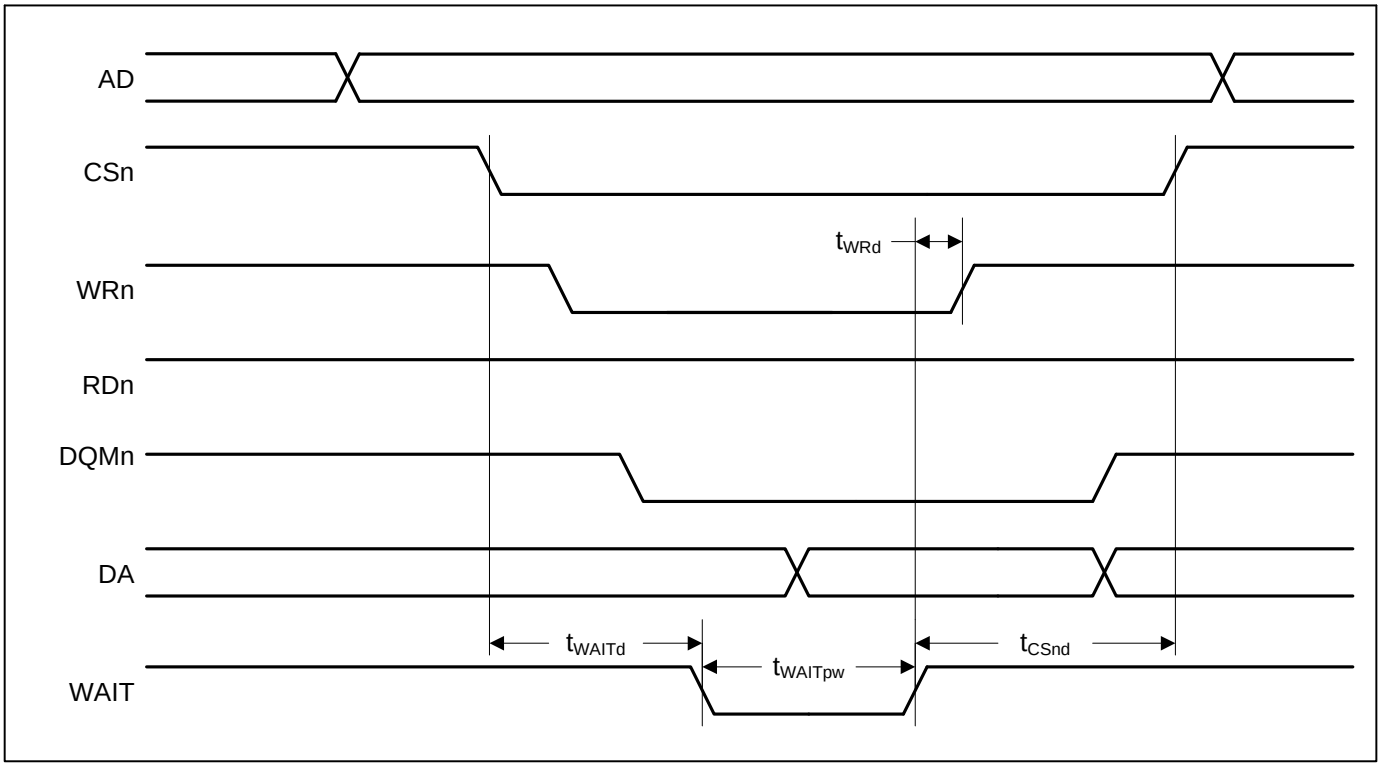


Figure 13. Static Memory Single Write Wait Cycle Timing Measurement

Motorola SPI

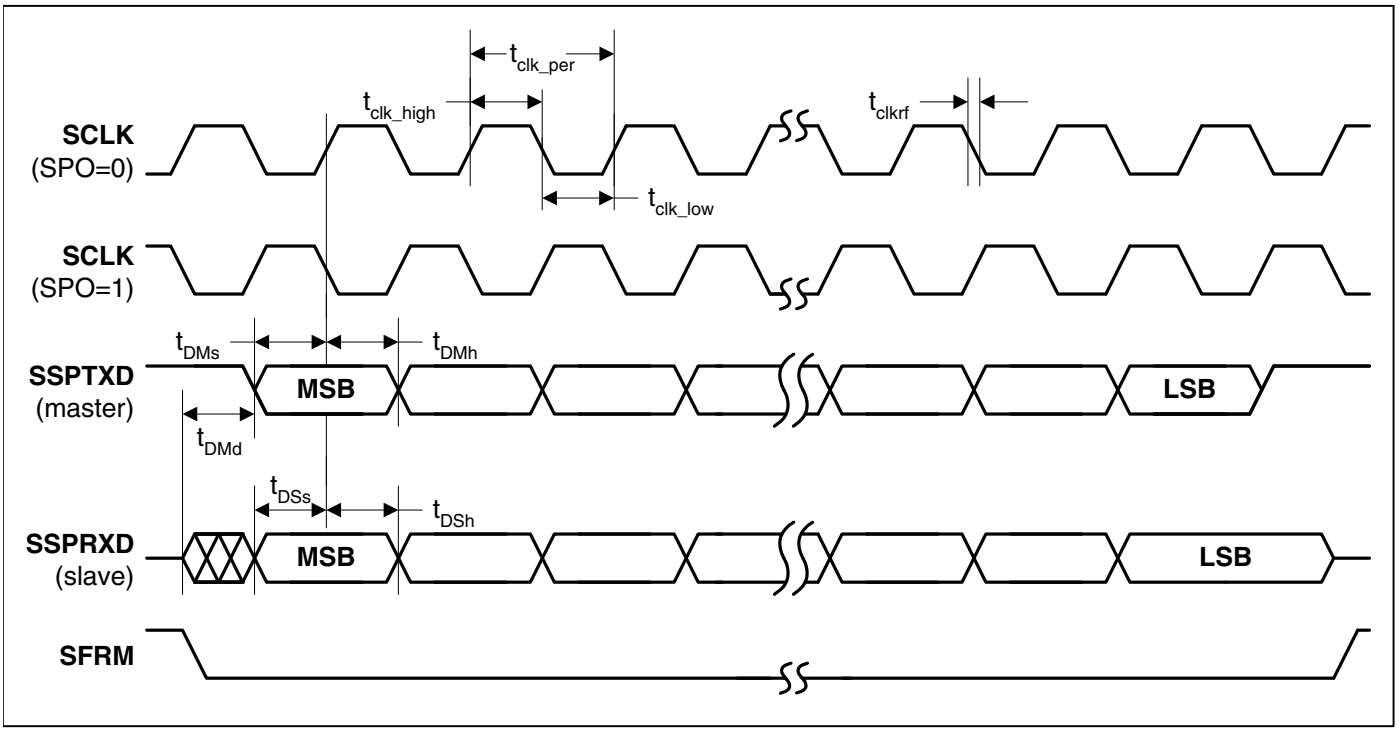


Figure 18. SPI Format with SPH=1 Timing Measurement

AC'97

Parameter	Symbol	Min	Typ	Max	Unit
ABITCLK input cycle time	t_{clk_per}	-	81.4	-	ns
ABITCLK input high time	t_{clk_high}	36	-	45	ns
ABITCLK input low time	t_{clk_low}	36	-	45	ns
ABITCLK input rise/fall time	t_{clkrf}	2	-	6	ns
ASDI setup to ABITCLK falling	t_s	10	-	-	ns
ASDI hold after ABITCLK falling	t_h	10	-	-	ns
ASDI input rise/fall time	t_{rfin}	2	-	6	ns
ABITCLK rising to ASDO / ASYNC valid, C_L = 55 pF	t_{co}	2	-	15	ns
ASYNC / ASDO rise/fall time, C_L = 55 pF	t_{rfout}	2	-	6	ns

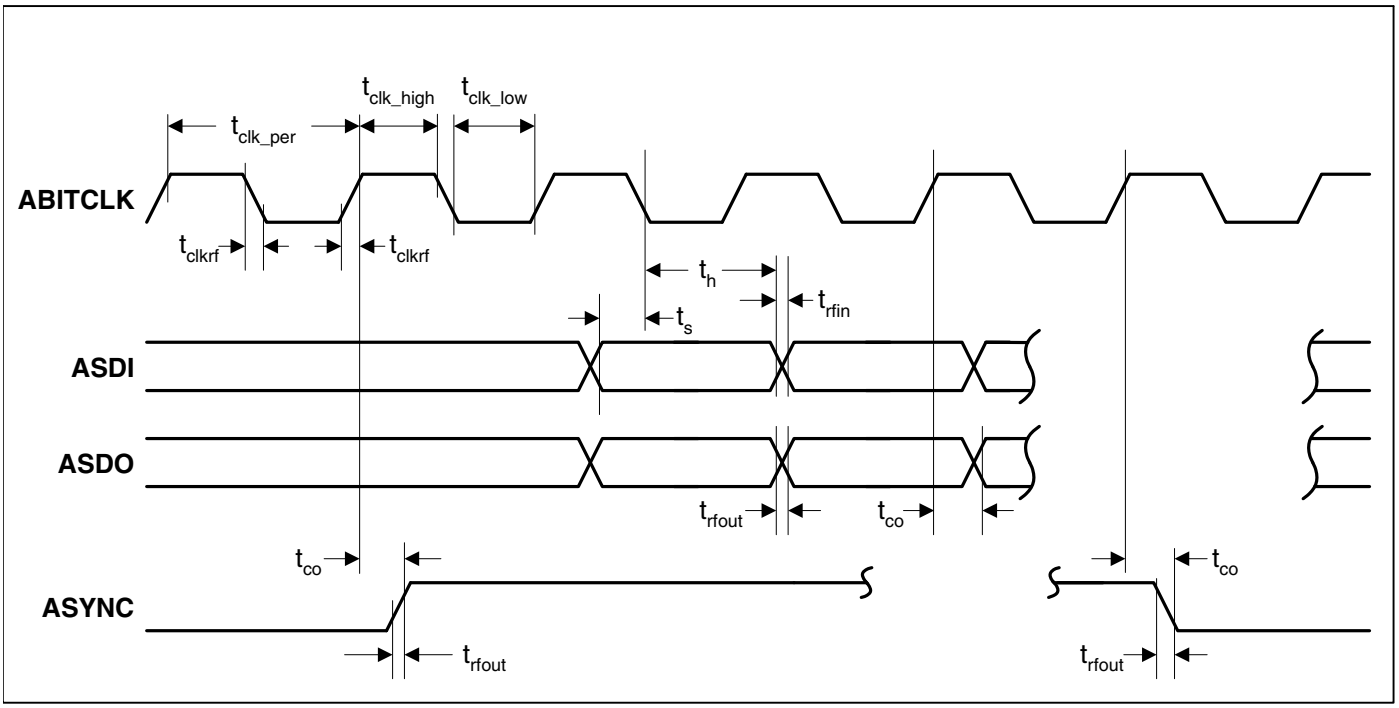
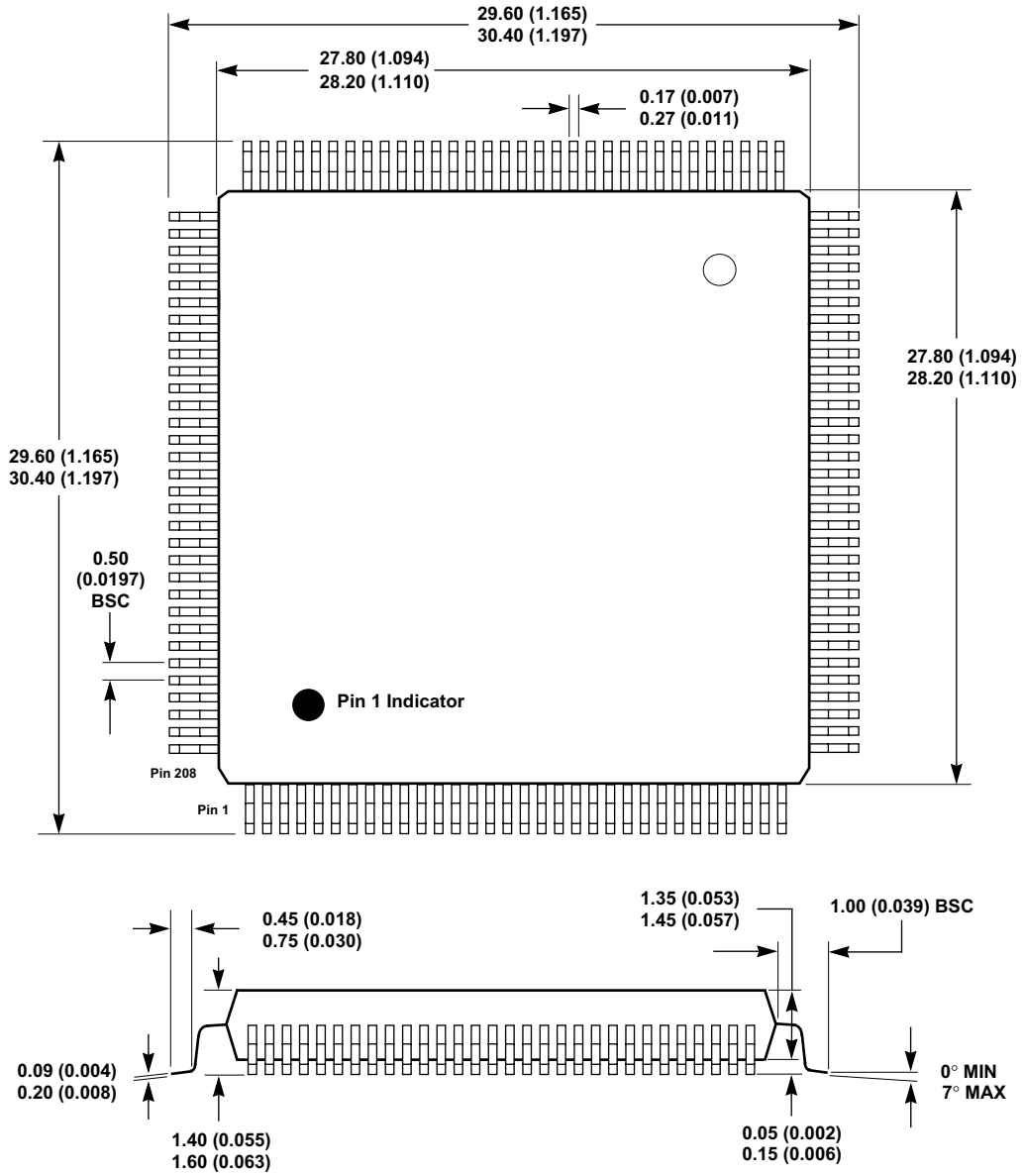


Figure 20. AC '97 Configuration Timing Measurement

208 Pin LQFP Package Outline

208-Pin LQFP (28 × 28 × 1.40-mm Body)



NOTES:

1) Dimensions are in millimeters, and controlling dimension is millimeter.
2) Package body dimensions do not include mold protrusion, which is 0.25 mm (0.010 in).
3) Pin 1 identification may be either ink dot or dimple.
4) Package top dimensions can be smaller than bottom dimensions by 0.20 mm (0.008 in).
5) The 'lead width with plating' dimension does not include a total allowable dambar protrusion of 0.08 mm (at maximum material condition).
6) Ejector pin marks in molding are present on every package.
7) Drawing above does not reflect exact package pin count.

Table R illustrates the pin signal multiplexing and configuration options.

Table R. Pin Multiplex Usage Information

Physical Pin Name	Description	Multiplex signal name
EGPIO[0]	Ring Indicator Input	RI
EGPIO[1]	1Hz clock monitor	CLK1HZ
EGPIO[3]	HDLC Clock	HDLCCLK1
EGPIO[4]	I2S Transmit Data 1	SDO1
EGPIO[5]	I2S Receive Data 1	SDI1
EGPIO[6]	I2S Transmit Data 2	SDO2
EGPIO[7]	DMA Request 0	DREQ0
EGPIO[8]	DMA Acknowledge 0	DACK0
EGPIO[9]	DMA EOT 0	DEOT0
EGPIO[10]	DMA Request 1	DREQ1
EGPIO[11]	DMA Acknowledge 1	DACK1
EGPIO[12]	DMA EOT 1	DEOT1
EGPIO[13]	I2S Receive Data 2	SDI2
EGPIO[14]	PWM1 Output	PWMOUT1
EGPIO[15]	Device active / present	DASP
ABITCLK	I2S Serial clock	SCLK
ASYNC	I2S Frame Clock	LRCK
ASDO	I2S Transmit Data 0	SDO0
ASDI	I2S Receive Data 0	SDI0
ARSTn	I2S Master clock	MCLK
SCLK1	I2S Serial clock	SCLK
SFRM1	I2S Frame Clock	LRCK
SSPTX1	I2S Transmit Data 0	SDO0
SSPRX1	I2S Receive Data 0	SDI0

Acronyms and Abbreviations

The following tables list abbreviations and acronyms used in this data sheet.

Term	Definition
ADC	Analog-to-Digital Converter
ALT	Alternative
AMBA	Advanced Micro-controller Bus Architecture
ATAPI	ATA Packet Interface
CODEC	COder / DECoder
CRC	Cyclic Redundancy Check
DAC	Digital-to-Analog Converter
DMA	Direct-Memory Access
EEPROM	Electronically Erasable Programmable Read Only Memory
EMAC	Ethernet Media Access Controller
EBUS	External Memory Bus
FIFO	First In / First Out
FIQ	Fast Interrupt Request
FLASH	Flash memory
GPIO	General Purpose I/O
HDLC	High-level Data Link Control
I/F	Interface
I^2S	Inter-IC Sound
IC	Integrated Circuit
ICE	In-Circuit Emulator
IDE	Integrated Drive Electronics
IEEE	Institute of Electronics and Electrical Engineers
IrDA	Infrared Data Association
IRQ	Standard Interrupt Request
ISO	International Standards Organization
JTAG	Joint Test Action Group
LFSR	Linear Feedback Shift Register
MII	Media Independent Interface
MMU	Memory Management Unit
OHCI	Open Host Controller Interface
PHY	Ethernet PHYsical layer interface
PIO	Programmed I/O
RISC	Reduced Instruction Set Computer
SDMI	Secure Digital Music Initiative
SDRAM	Synchronous Dynamic RAM
SPI	Serial Peripheral Interface
SRAM	Static Random Access Memory
STA	Station - Any device that contains an IEEE 802.11 conforming Medium Access Control (MAC) and physical layer (PHY) interface to the wireless medium
TFT	Thin Film Transistor
TLB	Translation Lookaside Buffer
USB	Universal Serial Bus

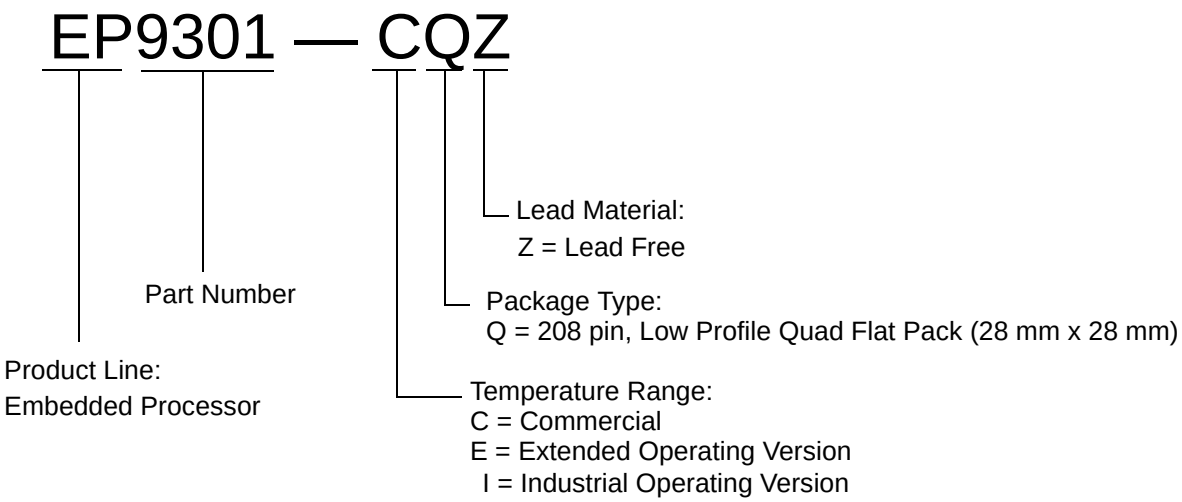
Units of Measurement

Symbol	Unit of Measure
^{o}C	degree Celsius
Hz	Hertz = cycle per second
kbps	Kilobits per second
kbyte	Kilobyte
KHz	KiloHertz = 1000 Hz
Mbps	Megabits per second
MHz	MegaHertz = 1,000 KiloHertz
µA	microAmpere = 10^{-6} Ampere
µs	microsecond = 1,000 nanoseconds = 10^{-6} seconds
mA	milliAmpere = 10^{-3} Ampere
ms	millisecond = 1,000 microseconds = 10^{-3} seconds
mW	milliWatt = 10^{-3} Watts
ns	nanosecond = 10^{-9} seconds
pF	picoFarad = 10^{-12} Farads
V	Volt
W	Watt

ORDERING INFORMATION

The order numbers for the device are:

EP9301-CQZ	0°C to +70°C	208-pin LQFP	Lead Free
EP9301-IQZ	-40°C to +85°C	208-pin LQFP	Lead Free



Note: Go to the Cirrus Logic Internet site at http://www.cirrus.com to find contact information for your local sales representative.